

RoHS Compliant Product

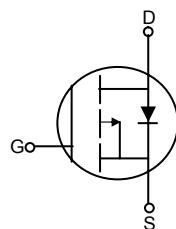
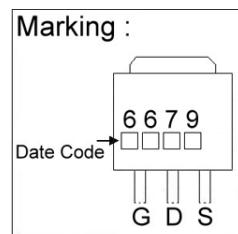
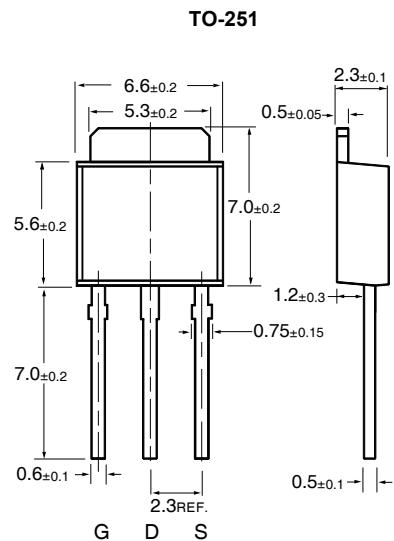
Description

The SID6679 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-251 is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

Features

- * Low On-Resistance
- * Simple Drive Requirement
- * Fast Switching Characteristic



Dimensions in millimeters

Absolute Maximum Ratings

| Parameter | Symbol | Ratings | Unit |
|--|--|----------|------|
| Drain-Source Voltage | V _{DS} | -30 | V |
| Gate-Source Voltage | V _{GS} | ±25 | V |
| Continuous Drain Current, V _{GS} @10V | I _D @T _c =25°C | -75 | A |
| Continuous Drain Current, V _{GS} @10V | I _D @T _c =100 °C | -50 | A |
| Pulsed Drain Current ¹ | I _{DM} | -300 | A |
| Total Power Dissipation | P _D @T _c =25°C | 89 | W |
| Linear Derating Factor | | 0.71 | W/°C |
| Operating Junction and Storage Temperature Range | T _j , T _{stg} | -55~+150 | °C |

Thermal Data

| Parameter | Symbol | Ratings | Unit |
|-------------------------------------|--------------------|---------|------|
| Thermal Resistance Junction-case | R _{thj-c} | 1.4 | °C/W |
| Thermal Resistance Junction-ambient | R _{thj-a} | 110 | °C/W |

Electrical Characteristics(Tj=25°C Unless otherwise specified)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|--|-----------|------|-------|------|------|--|
| Drain-Source Breakdown Voltage | BVDSS | -30 | — | — | V | VGS=0V, ID=-250uA |
| Breakdown Voltage Temp. Coefficient | ΔBVDS/ΔTj | — | -0.03 | — | V/°C | Reference to 25°C, ID=-1mA |
| Gate Threshold Voltage | VGS(th) | -1.0 | — | -3.0 | V | VDS=VGS, ID=-250uA |
| Gate-Source Leakage Current | IGSS | — | — | ±100 | nA | VGS=±25V |
| Drain-Source Leakage Current (Tj=25°C) | IDSS | — | — | -1 | uA | VDS=-30V, VGS=0 |
| Drain-Source Leakage Current(Tj=150°C) | | — | — | -25 | uA | VDS=-24V, VGS=0 |
| Static Drain-Source On-Resistance ² | RDS(ON) | — | — | 9 | mΩ | VGS=-10V, ID=-30A |
| | | — | — | 15 | | VGS=-4.5V, ID=-24A |
| Total Gate Charge ² | Qg | — | 42 | 67 | nC | Id=-16A VDS=-24V VGS=4.5V |
| Gate-Source Charge | Qgs | — | 6 | — | | |
| Gate-Drain ("Miller") Charge | Qgd | — | 25 | — | | |
| Turn-on Delay Time ² | TD(on) | — | 11 | — | nS | VDD=-15V Id=-16A VGS=-10V RG=3.3Ω RD=0.94Ω |
| Rise Time | Tr | — | 35 | — | | |
| Turn-off Delay Time | TD(off) | — | 58 | — | | |
| Fall Time | Tf | — | 78 | — | | |
| Input Capacitance | Ciss | — | 2870 | 4590 | pF | VGS=0V VDS=25V f=1.0MHz |
| Output Capacitance | Coss | — | 960 | — | | |
| Reverse Transfer Capacitance | Crss | — | 740 | — | | |
| Forward Transconductance | Gfs | — | 34 | — | S | VDS=-10V, ID=-24A |

Source-Drain Diode

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|------------------------------------|--------|------|------|------|------|-----------------------------------|
| Forward On Voltage ² | VSD | — | — | -1.2 | V | Is=-24A, VGS=0V. |
| Reverse Recovery Time ² | Trr | — | 47 | — | nS | Is=-16A, VGS=0V. dI/dt=100A/us |
| Reverse Recovery Change | Qrr | — | 43 | — | | |

Notes: 1.Pulse width limited by Max. junction temperature.

2.Pulse width≤300us, dutycycle≤2%.

Characteristics Curve

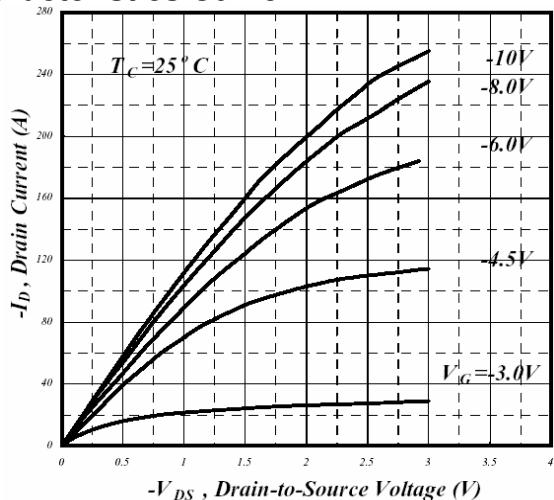


Fig 1. Typical Output Characteristics

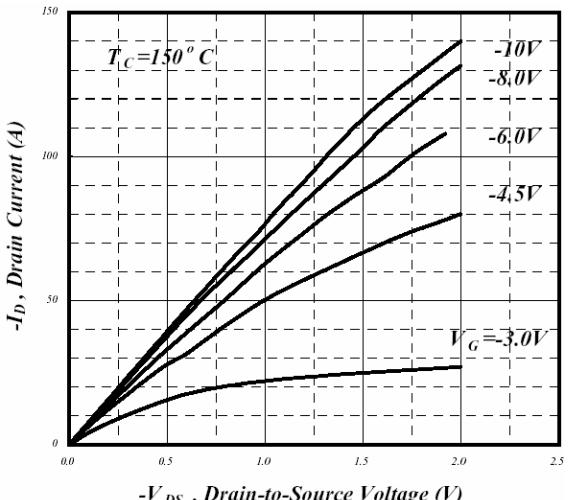


Fig 2. Typical Output Characteristics

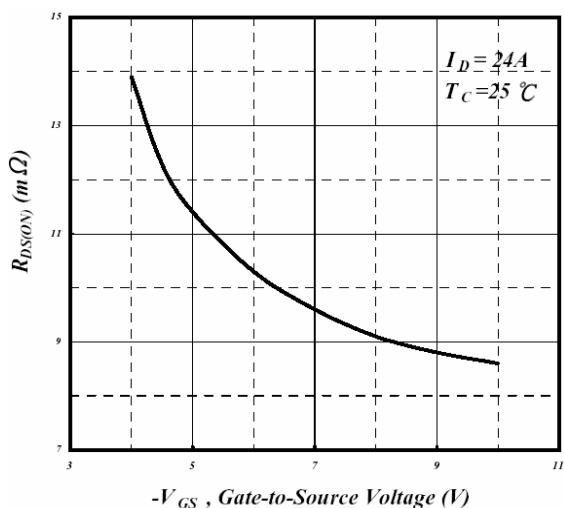


Fig 3. On-Resistance v.s. Gate Voltage

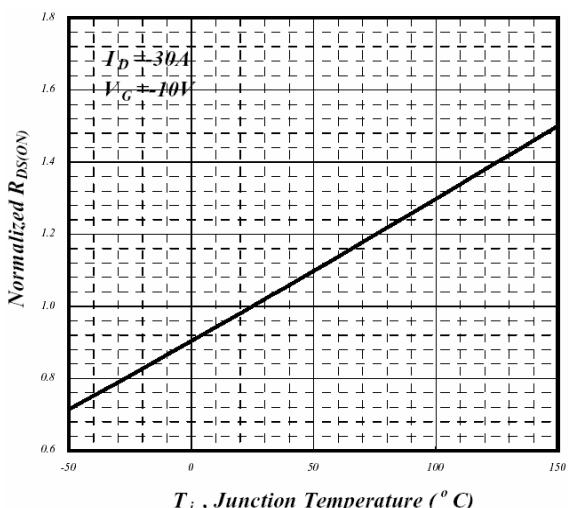


Fig 4. Normalized On-Resistance v.s. Junction Temperature

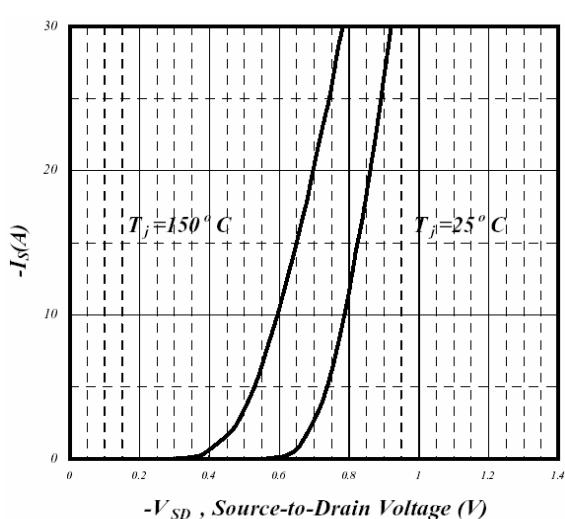


Fig 5. Forward Characteristics of Reverse Diode

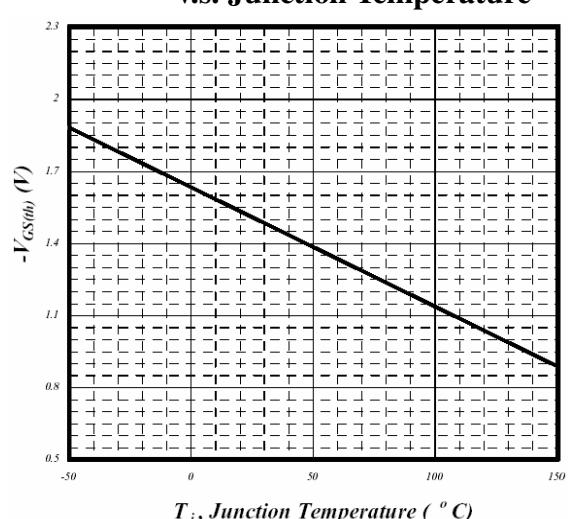


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

Any changing of specification will not be informed individual

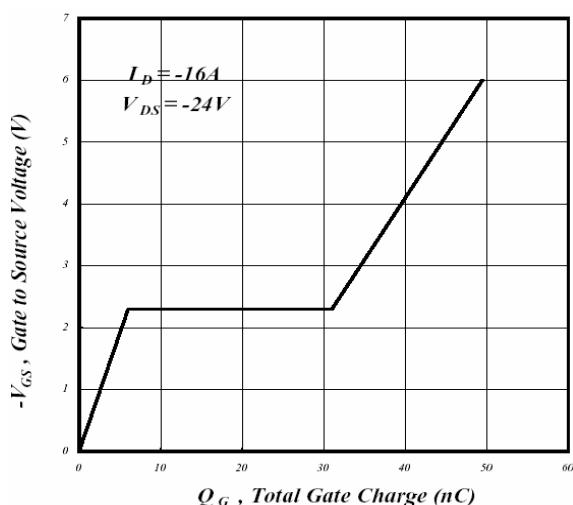


Fig 7. Gate Charge Characteristics

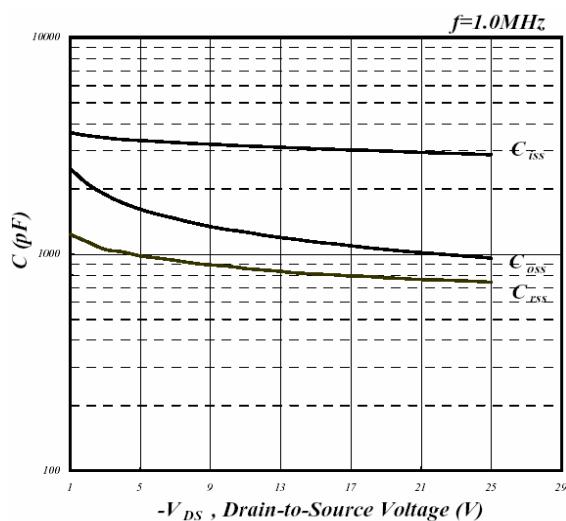


Fig 8. Typical Capacitance Characteristics

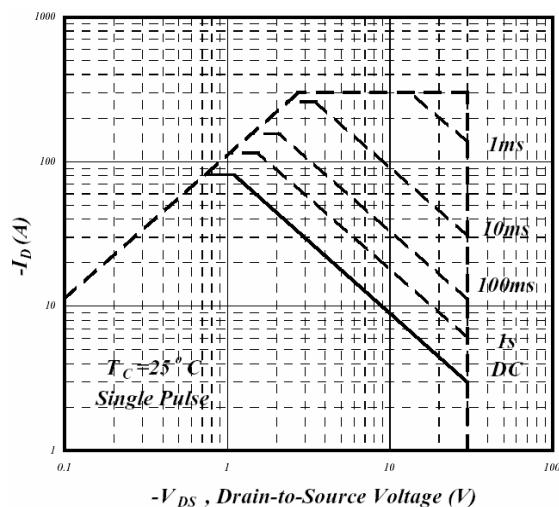


Fig 9. Maximum Safe Operating Area

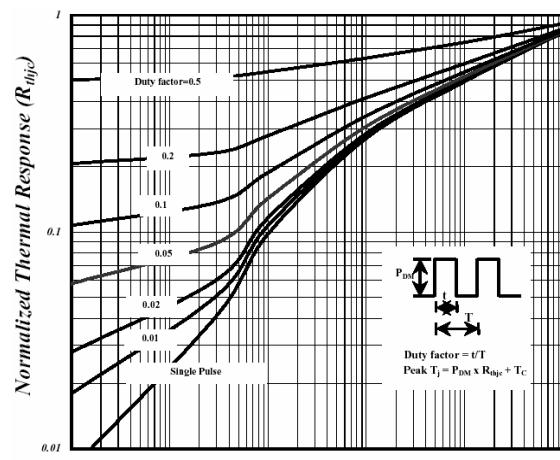


Fig 10. Effective Thermal Impedance

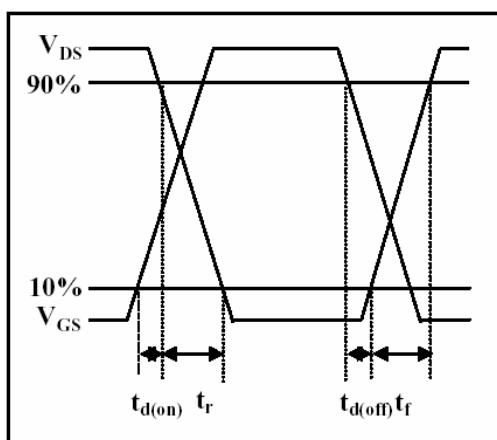


Fig 11. Switching Time Waveform

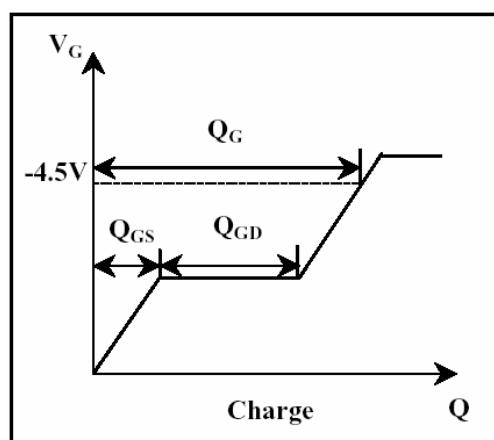


Fig 12. Gate Charge Waveform